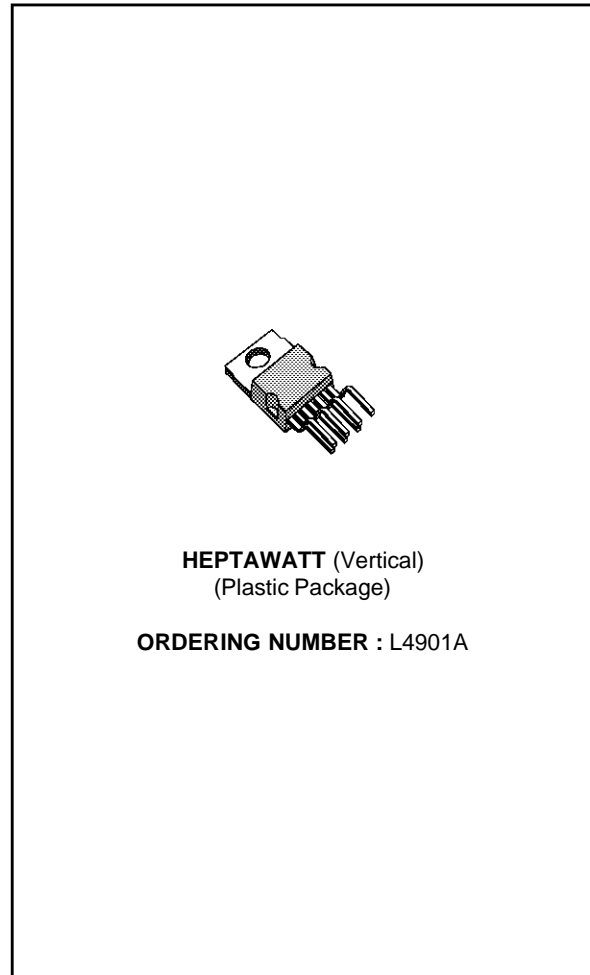


**DUAL 5V REGULATOR WITH RESET**

PRELIMINARY DATA

- OUTPUT CURRENTS :  $I_{O1} = 400\text{mA}$   
 $I_{O2} = 400\text{mA}$
- FIXED PRECISION OUTPUT VOLTAGE  
 $5\text{V} \pm 2\%$
- RESET FUNCTION CONTROLLED BY INPUT VOLTAGE AND OUTPUT 1 VOLTAGE
- RESET FUNCTION EXTERNALLY PROGRAMMABLE TIMING
- RESET OUTPUT LEVEL RELATED TO OUTPUT 2
- OUTPUT 2 INTERNALLY SWITCHED WITH ACTIVE DISCHARGING
- LOW LEAKAGE CURRENT, LESS THAN  $1\mu\text{A}$  AT OUTPUT 1
- LOW QUIESCENT CURRENT (Input 1)
- INPUT OVERVOLTAGE PROTECTION UP TO 60V
- RESET OUTPUT HIGH
- OUTPUT TRANSISTORS SO A PROTECTION
- SHORT CIRCUIT AND THERMAL OVERLOAD PROTECTION

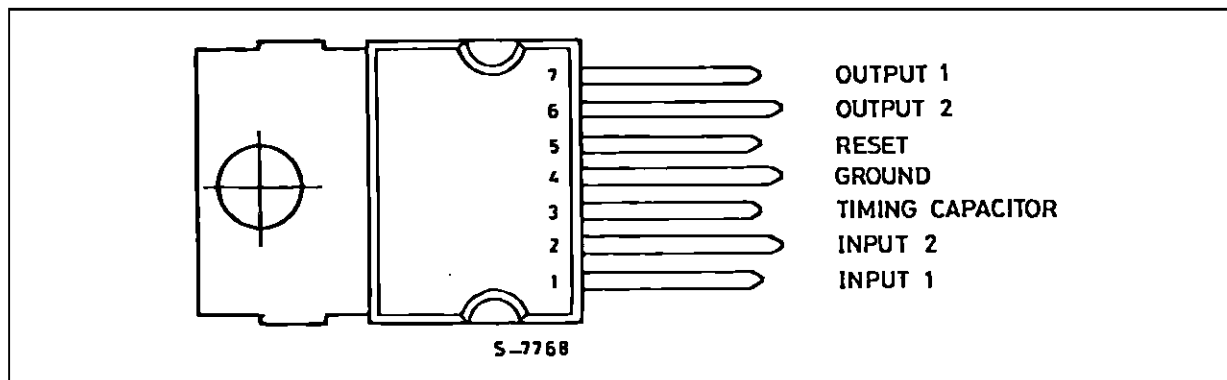


**DESCRIPTION**

The L4901A is a monolithic low drop dual 5V regulator designed mainly for supplying microprocessor systems.

Reset and data save functions during switch on/off can be realized.

**PIN CONNECTION**

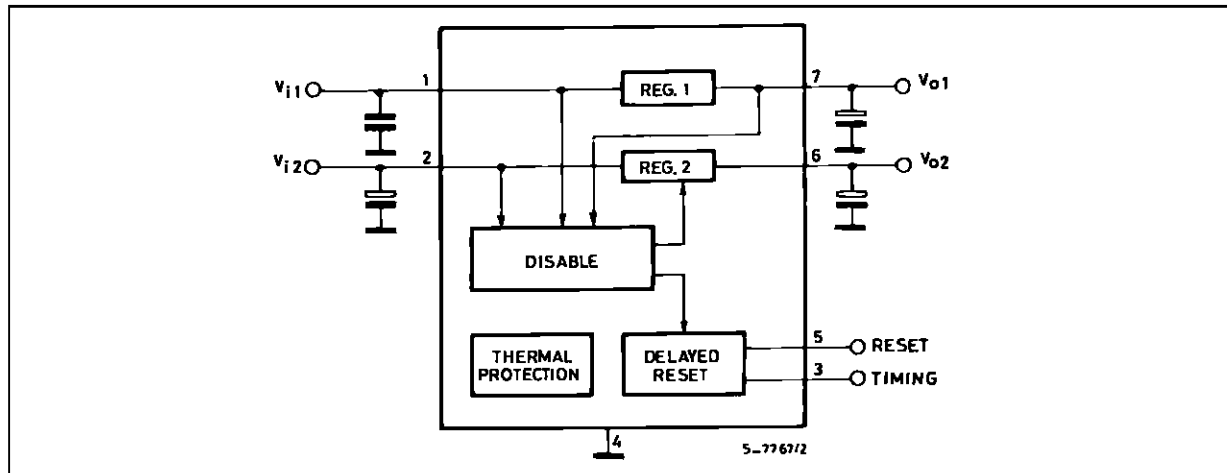


# L4901A

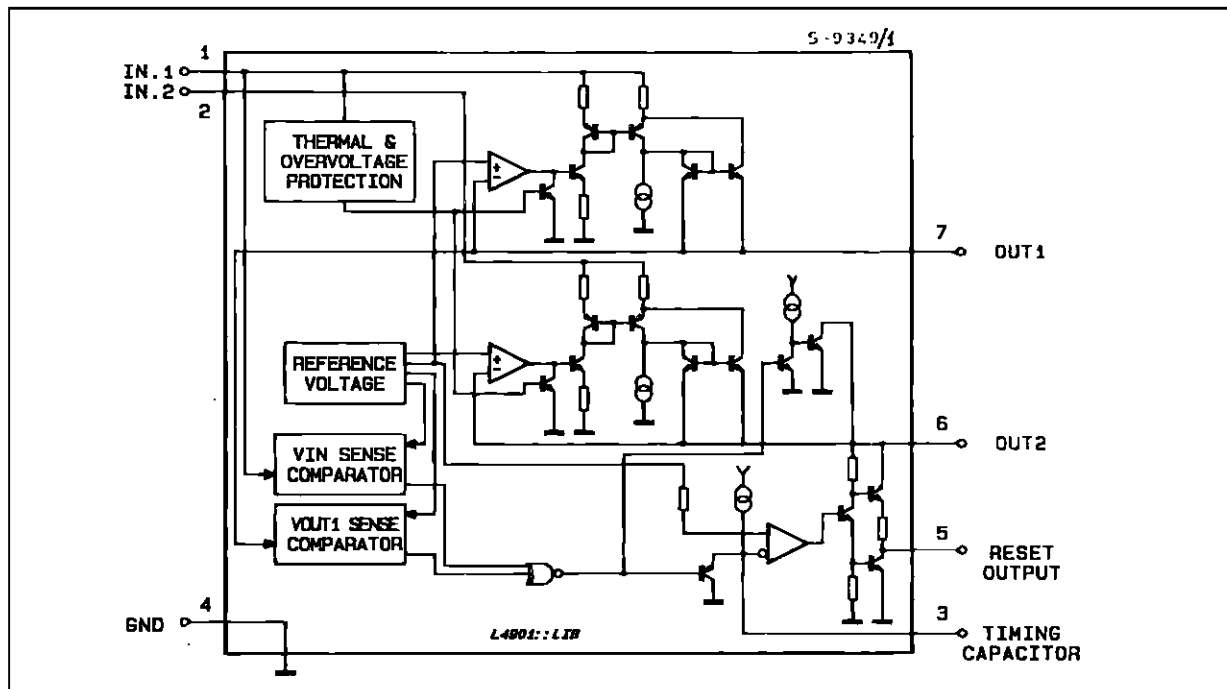
## PIN DESCRIPTION

N°	Name	Function
1	Input 1	Low Quiescent Current 400mA Regulator Input.
2	Input 2	400mA regulator input.
3	Timing Capacitor	If Reg. 2 is switched-ON the delay capacitor is charged with a 10µA constant current. When Reg. 2 is switched-OFF the delay capacitor is discharged.
4	GND	Common Ground.
5	Reset Output	When pin 3 reaches 5V the reset output is switched high. Therefore $t_{RD} = C_t \left( \frac{5V}{10\mu A} \right)$ ; $t_{RD} (ms) = C_t (nF)$
6	Output 2	5V – 400mA Regulator Output. Enabled if $V_o 1 > V_{RT}$ and $V_{IN 2} > V_{IT}$ . If Reg. 2 is switched-OFF the $C_{O2}$ capacitor is discharged.
7	Output 1	5V – 400mA regulator output with Low leakage (in switch-OFF condition).

## BLOCK DIAGRAM



## SCHEMATIC DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_{IN}$	DC Input Voltage	24	V
	Transient Input Overvoltage (t = 40ms)	60	V
$I_o$	Output Current	Internally Limited	
$T_j$	Storage and Junction Temperature	- 40 to 150	°C

## THERMAL DATA

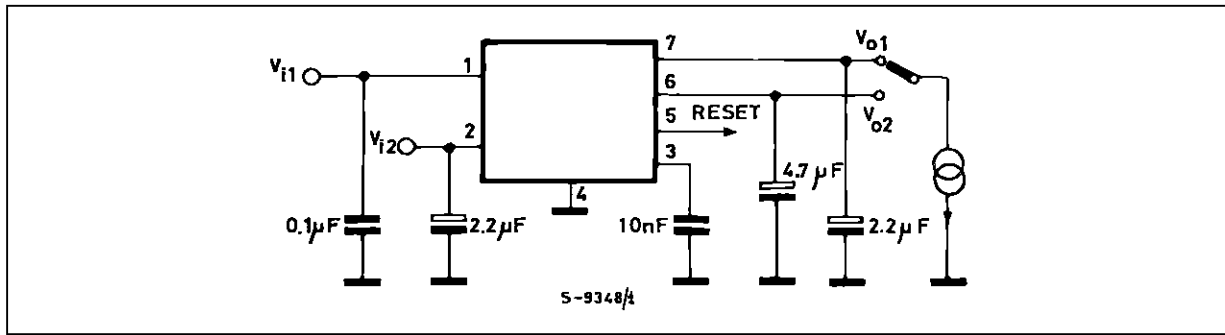
Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Thermal Resistance Junction-case	Max. 4	°C/W

ELECTRICAL CHARACTERISTICS ( $V_{IN} = 14, 4V$ ,  $T_{amb} = 25^\circ C$  unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_i$	DC Operating Input Voltage				20	V
$V_{O1}$	Output Voltage 1	R Load 1k $\Omega$	4.95	5.05	5.15	V
$V_{O2H}$	Output Voltage 2 HIGH	R Load 1k $\Omega$	$V_{O1} - 0.1$	5	$V_{O1}$	V
$V_{O2L}$	Output Voltage 2 LOW	$I_{O2} = -5mA$		0.1		V
$I_{O1}$	Output Current 1	$\Delta V_{O1} = -100mV$	400			mA
$I_{L01}$	Leakage Output 1 Current	$V_{IN} = 0, V_{O1} \leq 3V$			1	$\mu A$
$I_{O2}$	Output Current 2	$\Delta V_{O2} = -100mV$	400			mA
$V_{I01}$	Output 1 Dropout Voltage (*)	$I_{O1} = 10mA$		0.7	0.8	V
		$I_{O1} = 100mA$		0.8	1	V
		$I_{O1} = 300mA$		1.1	1.4	V
$V_{IT}$	Input Threshold Voltage		$V_{O1} + 1.2$	6.4	$V_{O1} + 1.7$	V
$V_{ITH}$	Input Threshold Voltage Hyst.			250		mV
$\Delta V_{O1}$	Line Regulation 1	$7V < V_{IN} < 18V, I_{O1} = 5mA$		5	50	mV
$\Delta V_{O2}$	Line Regulation 2	$7V < V_{IN} < 18V, I_{O2} = 5mA$		5	50	mV
$\Delta V_{O1}$	Load Regulation 1	$5mA < I_{O1} < 400mA$		50	100	mV
$\Delta V_{O2}$	Load Regulation 2	$5mA < I_{O1} < 400mA$		50	100	mV
$I_Q$	Quiescent Current	$I_{O2} = I_{O1} \leq 5mA$		4.5	6.5	mA
		$0 < V_{IN} < 13V$ $7V < V_{IN} < 13V$		1.6	3.5	
$I_{Q1}$	Quiescent Current 1	$I_{O1} \leq 5mA, I_{O2} = 0, V_{IN2} = 0$ $6.3V < V_{IN} < 13V$		0.6	0.9	mA
$V_{RT}$	Reset Threshold Voltage		$V_{O2} - 0.15$	4.9	$V_{O2} - 0.05$	V
$V_{RTH}$	Reset Threshold Hysteresis		30	50	80	mV
$V_{RH}$	Reset Output Voltage HIGH	$I_R = 500\mu A$	$V_{O2} - 1$	4.12	$V_{O2}$	V
$V_{RL}$	Reset Output Voltage LOW	$I_R = -<0>5mA$		0.25	0.4	V
$t_{RD}$	Reset Pulse Delay	$C_t = 10nF$	3	5	11	ms
$t_d$	Timing Capacitor Discharge Time	$C_t = 10nF$			20	$\mu s$
$\frac{\Delta V_{O1}}{\Delta T}$	Thermal Drift	$-20^\circ C \leq T_{amb} \leq 125^\circ C$		0.3 - 0.8		mV/°C
$\frac{\Delta V_{O2}}{\Delta T}$	Thermal Drift	$-20^\circ C \leq T_{amb} \leq 125^\circ C$		0.3 - 0.8		mV/°C
SVR1	Supply Voltage Rejection	$f = 100Hz, V_R = 0.5V$ $I_o = 100mA$	50	84		dB
SVR2	Supply Voltage Rejection		50	80		dB
$T_{JSD}$	Thermal Shut Down			150		°C

\* The dropout voltage is defined as the difference between the input and the output voltage when the output voltage is lowered of 25 mV under constant output current condition.

TEST CIRCUIT



APPLICATION INFORMATION

In power supplies for  $\mu P$  systems it is necessary to provide power continuously to avoid loss of information in memories and in time of day clocks, or to save data when the primary supply is removed. The L4901A makes it very easy to supply such equipments ; it provides two voltage regulators (both 5 V high precision) with separate inputs plus a reset output for the data save function.

$V_{O2}$  and  $V_R$  are switched together at low level when one of the following conditions occurs :

- an input overvoltage
- an overload on the output 1 ( $V_{O1} < V_{RT}$ ) ;
- a switch off ( $V_{IN} < V_{IT} - V_{ITH}$ ) ;

and they start again as before when the condition is removed.

An overload on output 2 does not switch Reg. 2, and does not influence Reg. 1.

The  $V_{O1}$  output features :

- 5 V internal reference without voltage divider between the output and the error comparator ;
- very low drop series regulator element utilizing current mirrors ;

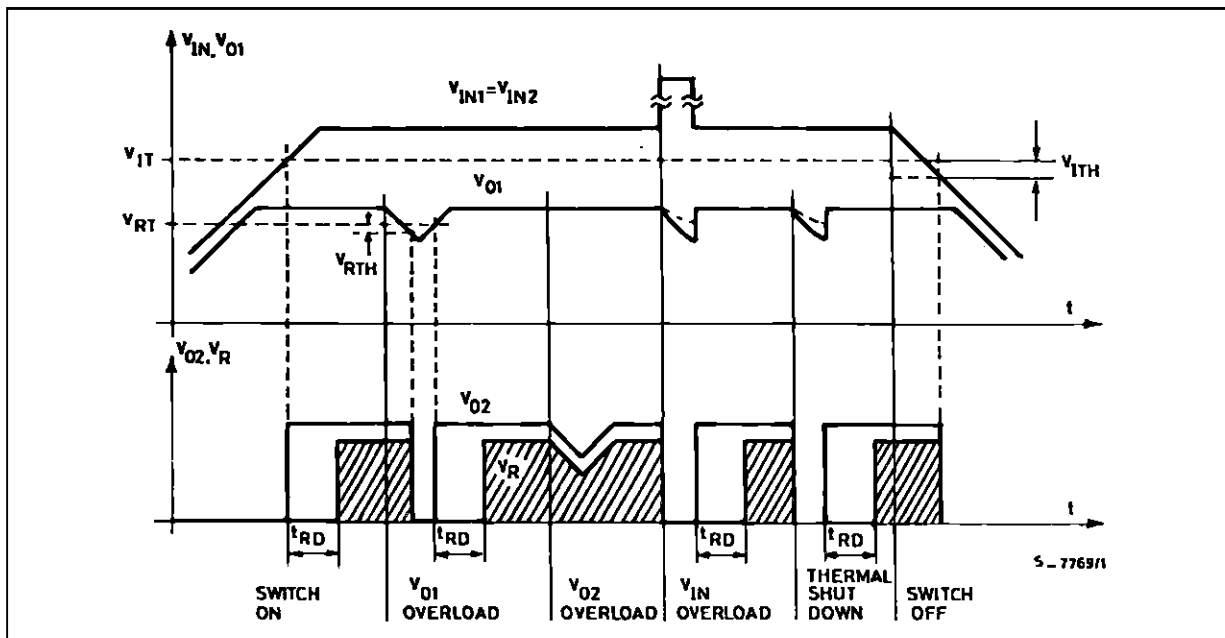
permit high output impedance and then very low leakage current error even in power down condition.

CIRCUIT OPERATION (see Figure 1)

After switch on Reg. 1 saturates until  $V_{O1}$  rises to the nominal value.

When the input 2 reaches  $V_{IT}$  and the output 1 is higher than  $V_{RT}$  the output 2 ( $V_{O2}$ ) switches on and the reset output ( $V_R$ ) also goes high after a programmable time  $T_{RD}$  (timing capacitor).

Figure 1



This output may therefore be used to supply circuits continuously, such as volatile RAMs, allowing the use of a back-up battery. The  $V_{01}$  regulator also features low consumption (0.6 mA typ.) to minimize battery drain in applications where the  $V_1$  regulator is permanently connected to a battery supply.

The  $V_{02}$  output can supply other non essential 5 V circuits which may be powered down when the system is inactive, or that must be powered down to prevent uncorrect operation for supply voltages below the minimum value.

The reset output can be used as a "POWER DOWN INTERRUPT", permitting RAM access only in correct power conditions, or as a "BACK-UP ENABLE"

to transfer data into in a NV SHADOW MEMORY when the supply is interrupted.

**APPLICATIONS SUGGESTIONS**

Figure 2 shows an application circuit for a  $\mu P$  system typically used in trip computers or in car radios with programmable tuning.

Reg. 1 is permanently connected to a battery and supplies a CMOS time-of-day clock and a CMOS microcomputer chip with volatile memory.

Reg. 2 may be switched OFF when the system is inactive.

Figure 2

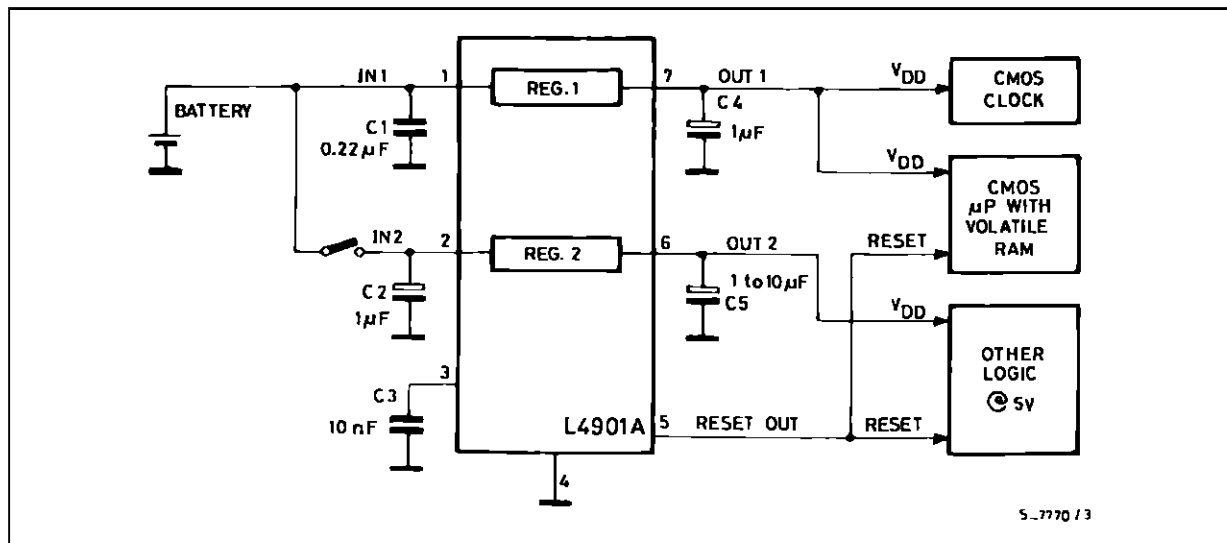
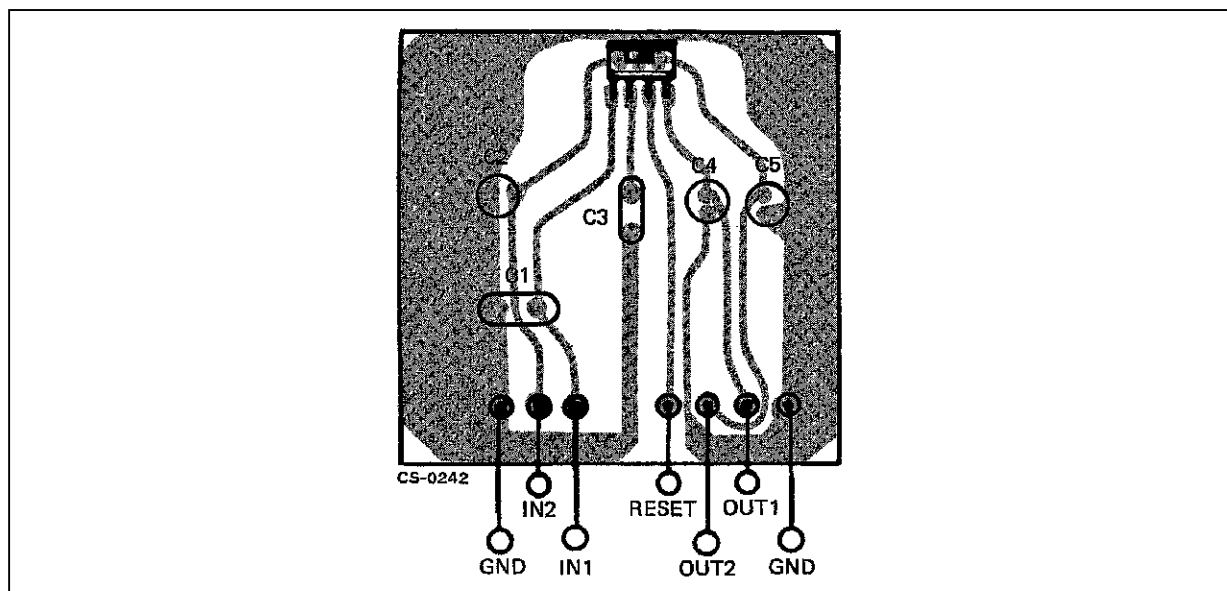


Figure 3 : P.C. Board Component Layout of Figure 2.





Another interesting application of the L4901A is in  $\mu$ P system with shadow memories (see Figure 6). When the input voltage goes below  $V_{IT}$ , the reset output enables the execution of a routine that saves the machine's state in the shadow RAM (xicor x 2201 for example).

Thanks to the low consumption of the Reg. 1 a 680  $\mu$ F capacitor on its input is sufficient to provide enough energy to complete the operation. The diode on the input guarantees the supply of the equipment even if a short circuit on  $V_1$  occurs.

Figure 6

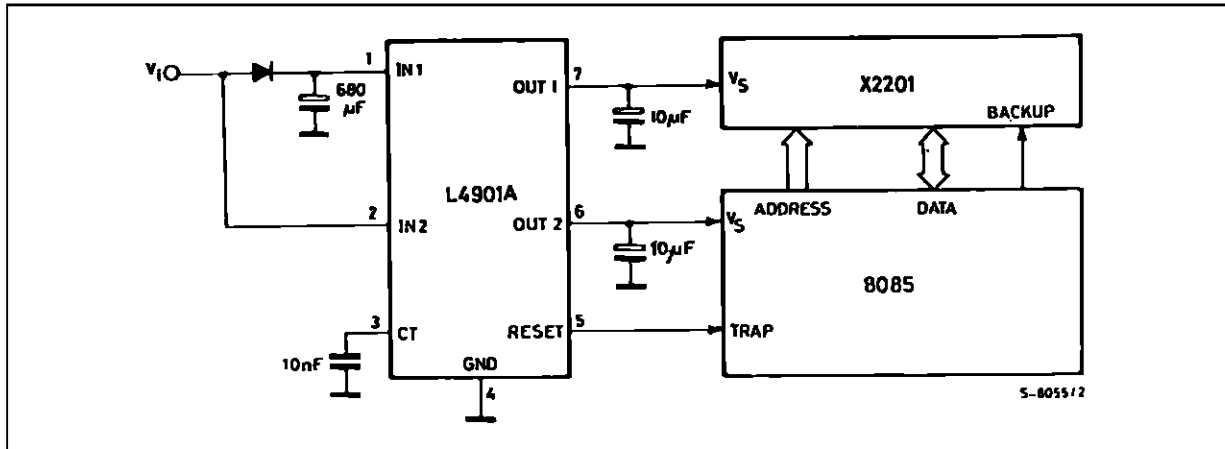


Figure 7 : Quiescent Current (reg.1) versus Output Current

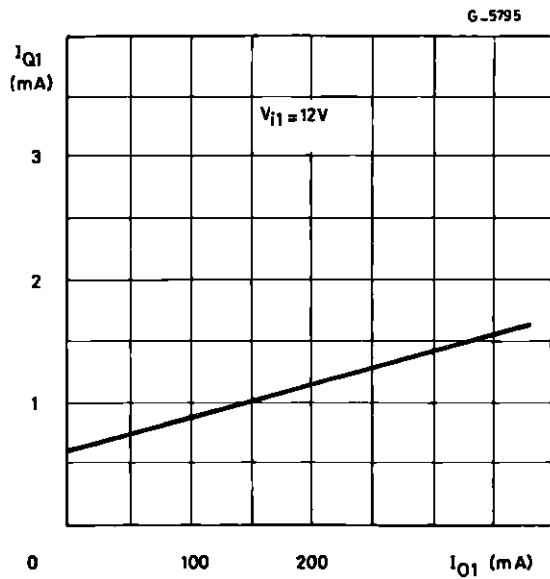
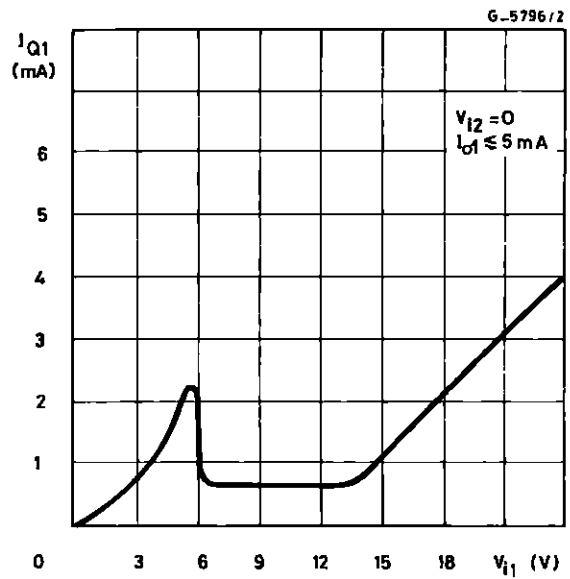
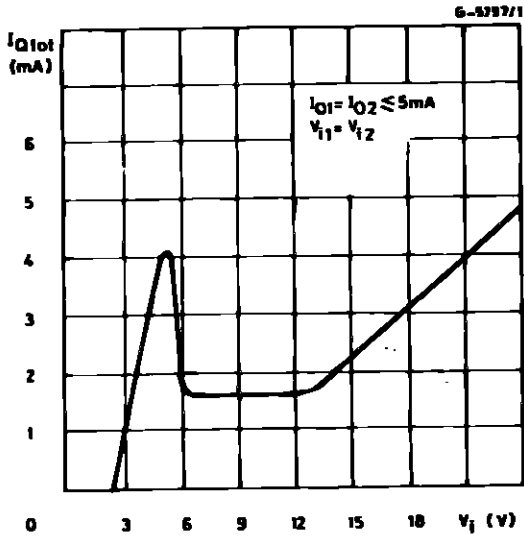


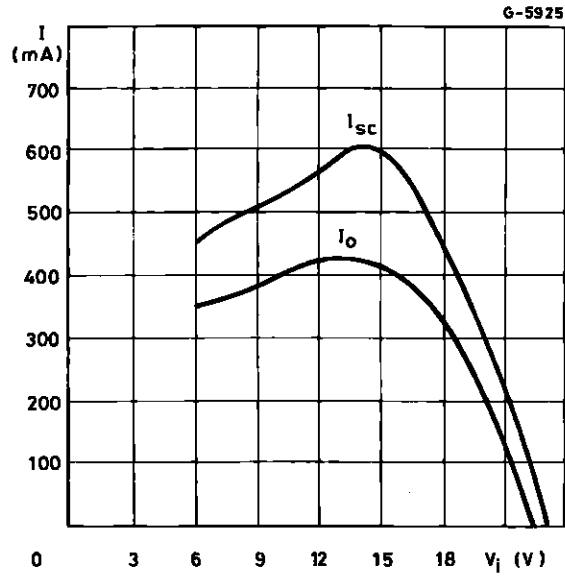
Figure 8 : Quiescent Current (reg.1) versus Input Voltage



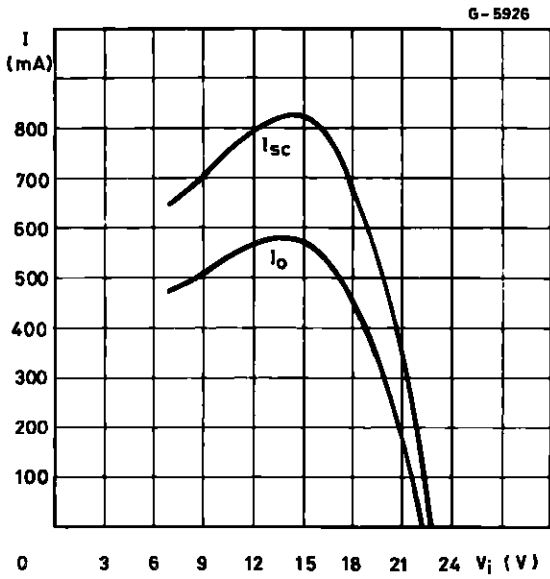
**Figure 9 :** Total Quiescent Current versus Input Voltage



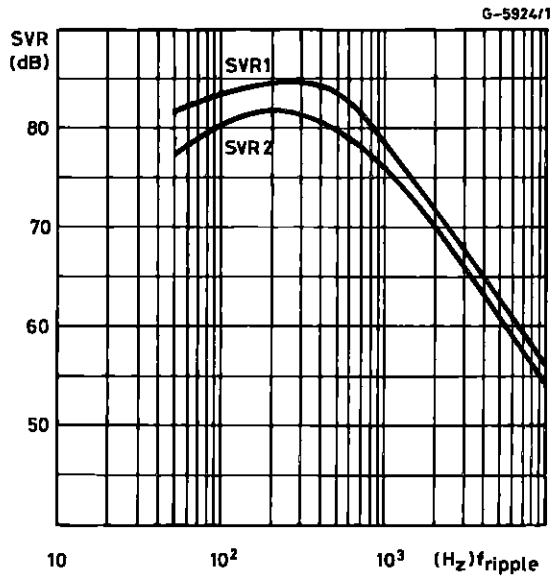
**Figure 10 :** Regulator 1 Output Current and Short Circuit Current versus Input Voltage



**Figure 11 :** Regulator 1 Output Current and Short Circuit Current versus Input Voltage



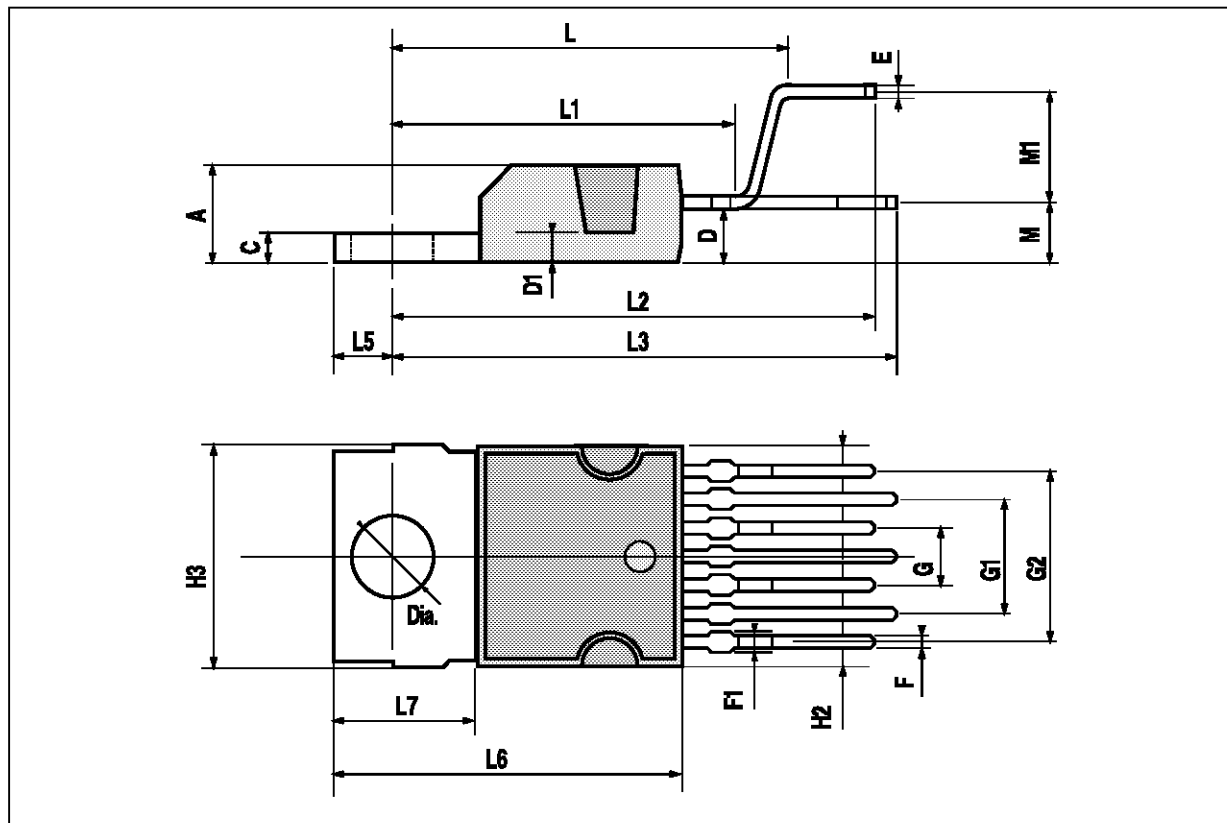
**Figure 12 :** Supply Voltage Rejection Regulators 1 and 2 versus Input Ripple Frequency





## HEPTAVATT PACKAGE MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			4.8			0.189
C			1.37			0.054
D	2.4		2.8	0.094		0.110
D1	1.2		1.35	0.047		0.053
E	0.35		0.55	0.014		0.022
F	0.6		0.8	0.024		0.031
F1			0.9			0.035
G	2.41	2.54	2.67	0.095	0.100	0.105
G1	4.91	5.08	5.21	0.193	0.200	0.205
G2	7.49	7.62	7.8	0.295	0.300	0.307
H2			10.4			0.409
H3	10.05		10.4	0.396		0.409
L		16.97			0.668	
L1		14.92			0.587	
L2		21.54			0.848	
L3		22.62			0.891	
L5	2.6		3	0.102		0.118
L6	15.1		15.8	0.594		0.622
L7	6		6.6	0.236		0.260
M		2.8			0.110	
M1		5.08			0.200	
Dia	3.65		3.85	0.144		0.152



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